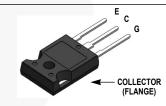


FGH40T65SPD 650 V, 40 A Field Stop Trench IGBT

Features

- Maximum Junction Temperature : $T_J = 175^{\circ}C$
- Positive Temperaure Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: V_{CE(sat)} = 1.85 V (Typ.) @ I_C = 40 A
- High Input Impedance
- · Fast Switching
- Tighten Parameter Distribution
- RoHS Compliant
- Short Circuit Ruggedness > 5 us @ 25°C





Using novel field stop IGBT technology, Fairchild's new series of field stop 3rd generation IGBTs offer the optimum performance

for solar inverter, UPS, welder, telecom, ESS and PFC applica-

tions where low conduction and switching losses are essential.

Solar Inverter UPS, Welder, PFC, Telecom, ESS

General Description

Applications

Absolute Maximum Ratings

Symbol	Description	l	FGH40T65SPD_F155	5 Unit
V _{CES}	Collector to Emitter Voltage		650	V
V _{GES}	Gate to Emitter Voltage		± 20	V
	Transient Gate to Emitter Voltage		± 30	V
I _C	Collector Current	@ T _C = 25°C	80	A
ιC.	Collector Current	@ T _C = 100 ^o C	40	A
I _{CM}	Pulsed Collector Current		120	A
I _F	Diode Forward Current	@ T _C = 25°C	40	A
'F	Diode Forward Current	@ T _C = 100 ^o C	20	A
I _{FM}	Pulsed Diode Maximum Forward Current		120	A
P _D	Maximum Power Dissipation	@ T _C = 25°C	267	W
' D	Maximum Power Dissipation	@ T _C = 100 ^o C	134	W
SCWT	Short Circuit Withstand Time	@ T _C = 25°C	5	μs
Т _Ј	Operating Junction Temperature		-55 to +175	°C
T _{stg}	Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 second	ds	300	°C

Notes:

1: Repetitive rating: Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
R _{0JC} (IGBT)	(IGBT) Thermal Resistance, Junction to Case		0.56	°C/W
$R_{\theta JC}$ (Diode)	(Diode) Thermal Resistance, Junction to Case		1.71	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W

		Package	Package Reel Size		Tape Width		Qty per Tube	
		TO-247 G03	-		-		30ea	
Electric	al Cha	racteristics of the	IGBT T _C = 25	°C unless otherwise noted				
Symbol		Parameter	Test	Test Conditions		Тур.	Max.	Unit
Off Charac	teristics							
BV _{CES}	Collector	to Emitter Breakdown Voltag	e V _{GE} = 0 V, I _C	; = 1 mA	650	-	-	V
ΔBV_{CES} ΔT_J	Tempera Voltage	ture Coefficient of Breakdow	$V_{GE} = 0 V, I_C$	c = 1 mA	_	0.6	-	V/ºC
I _{CES}	Collector	Cut-Off Current	V _{CE} = V _{CES} ,	V _{GE} = 0 V	-	-	250	μA
I _{GES}	G-E Leak	age Current	$V_{GE} = V_{GES},$		-	-	± 400	nA
On Charac	toristics					1		
V _{GE(th)}	1	shold Voltage	I _C = 40 mA, \		4	5.5	7.5	V
			$I_{\rm C} = 40 \text{ A}, \text{V}_{\rm G}$		· ·	1.85	2.4	V
V _{CE(sat)}	Collector	ollector to Emitter Saturation Voltage		$I_{C} = 40 \text{ A}, V_{GE} = 15 \text{ V},$ $T_{C} = 175^{\circ}\text{C}$		2.51	-	V
Dynamic C	haractoris	atics						
C _{ies}	Input Cap				-	1370	-	pF
C _{oes}		apacitance	V _{CE} = 30 V, V	V _{CE} = 30 V, V _{GE} = 0 V, f = 1 MHz		94	-	pF
C _{res}		Transfer Capacitance	f = 1 MHz			16	-	pF
	Character	iation						
Switching T _{d(on)}		Delay Time			_	16	_	ns
T _r	Rise Time	· · ·	-			42		ns
T _{d(off)}		Delay Time	V _{CC} = 400 V,	1 - 40 A	-	37	_	ns
T _f	Fall Time		$R_{\rm G} = 6 \Omega, V_{\rm G}$		_	11	_	ns
E _{on}		Switching Loss	Inductive Loa	ad, T _C = 25°C		1.16	-	mJ
E _{off}		Switching Loss			-	0.28	_	mJ
E _{ts}		tching Loss			-	1.44	- /	mJ
T _{d(on)}		Delay Time			-	14	-	ns
T _r	Rise Time		\neg		-	49	-	ns
T _{d(off)}		Delay Time	$V_{aa} = 400 V_{aa}$	400 V, I _C = 40 A,	-	38	-	ns
T _f	Fall Time		$R_{\rm G} = 6 \Omega, V_{\rm G}$		-	18	- /	ns
E _{on}		Switching Loss	Inductive Loa	ad, T _C = 175 ^o C	-	1.54	-	mJ
E _{off}		Switching Loss			-	0.52		mJ
E _{ts}		tching Loss	-		-	2.06	-	mJ
T _{SC}		cuit Withstand Time	V _{CC} = 400 V, R _G = 10 Ω	, V _{GE} = 15 V,	5	-	-	μs

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Electrical Characteristics of the IGBT (Continued)

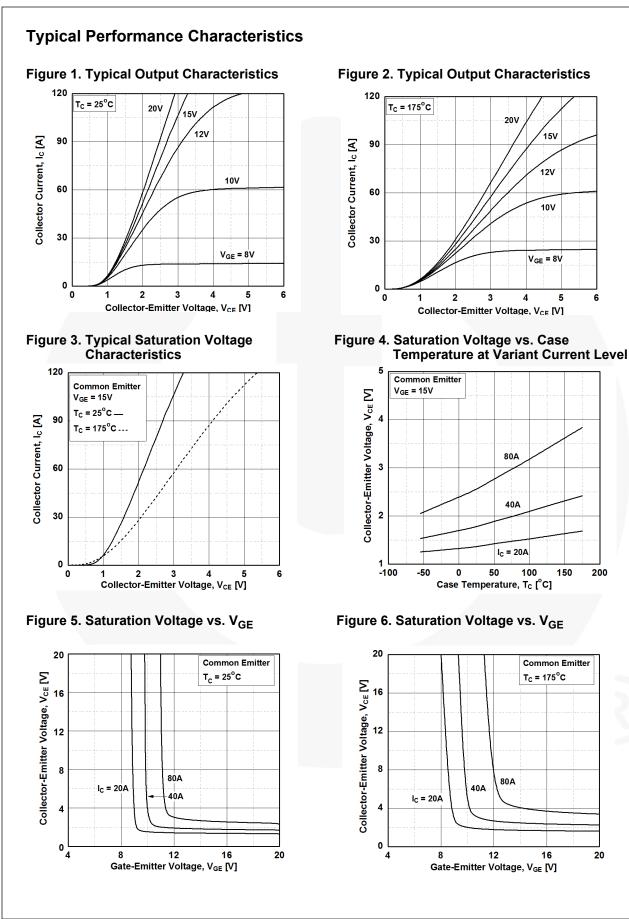
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Qg	Total Gate Charge		-	35	-	nC
Q _{ge}	Gate to Emitter Charge	V _{CE} = 400 V, I _C = 40 A, V _{GE} = 15 V	-	11	-	nC
Q _{gc}	Gate to Collector Charge	VGE - 13 V	-	12	-	nC

Electrical Characteristics of the Diode T_C = 25°C unless otherwise noted

Symbol	Parameter		Test Condition	ns	Min.	Тур.	Max.	Unit
V _{FM}	Diode Forward Voltage	I_ =	20 A	T _C = 25°C	-	2.2	2.7	V
	2.040 Pointard Pointage		2077	T _C = 175 ^o C	-	1.9	-	-
E _{rec}	Reverse Recovery Energy			T _C = 175 ^o C	-	76	-	μJ
Т"	Diode Reverse Recovery Time		20 A, dI _F /dt = 200 A/µs	T _C = 25 ^o C	-	34	-	ns
· m		'F -	20 Λ, αιμίαι - 200 Λ/μ3	T _C = 175 ^o C	- 1	196	-	
Q _{rr}	Diode Reverse Recovery Charge			T _C = 25°C	-	52	-	nC
~"	2.000 Hororor (000 vory charge			T _C = 175 ^o C	-	638	-	

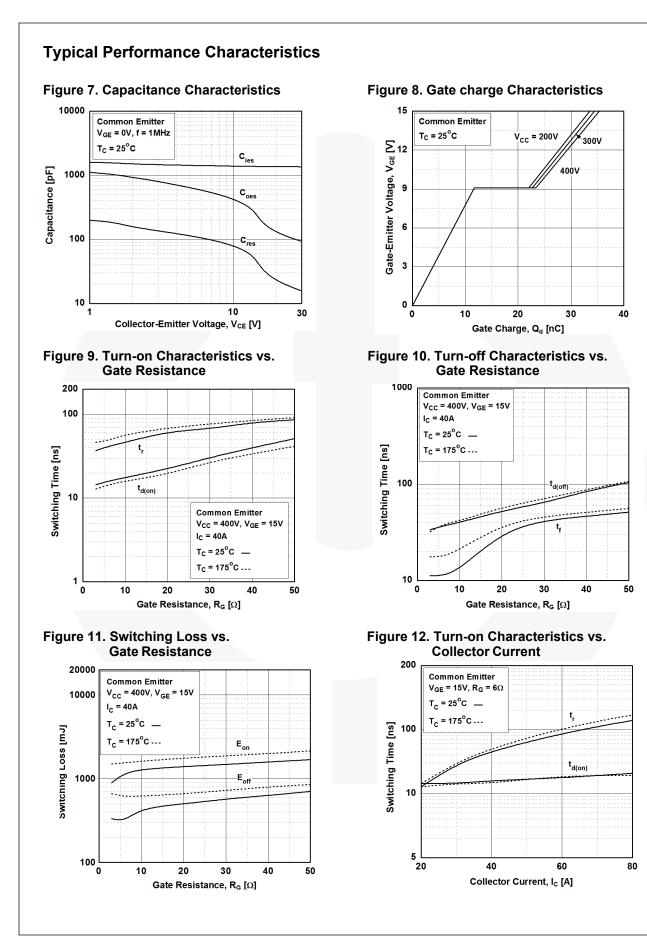
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Eon

Eoff

60

80

1000

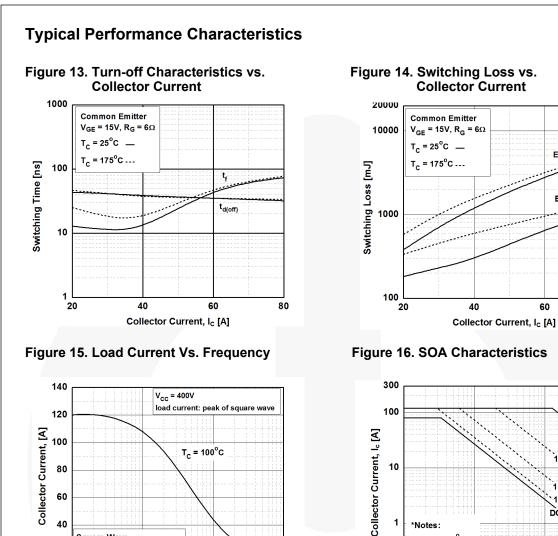
0us

100u

1 ms

100

10 ms



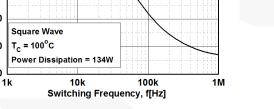


Figure 17. Forward Characteristics

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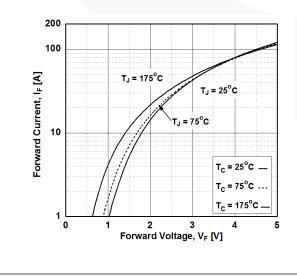


Figure 18. Reverse Recovery Current

10

Collector-Emitter Voltage, V_{CE} [V]

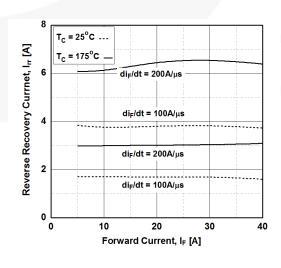
1. $T_{C} = 25^{\circ}C$

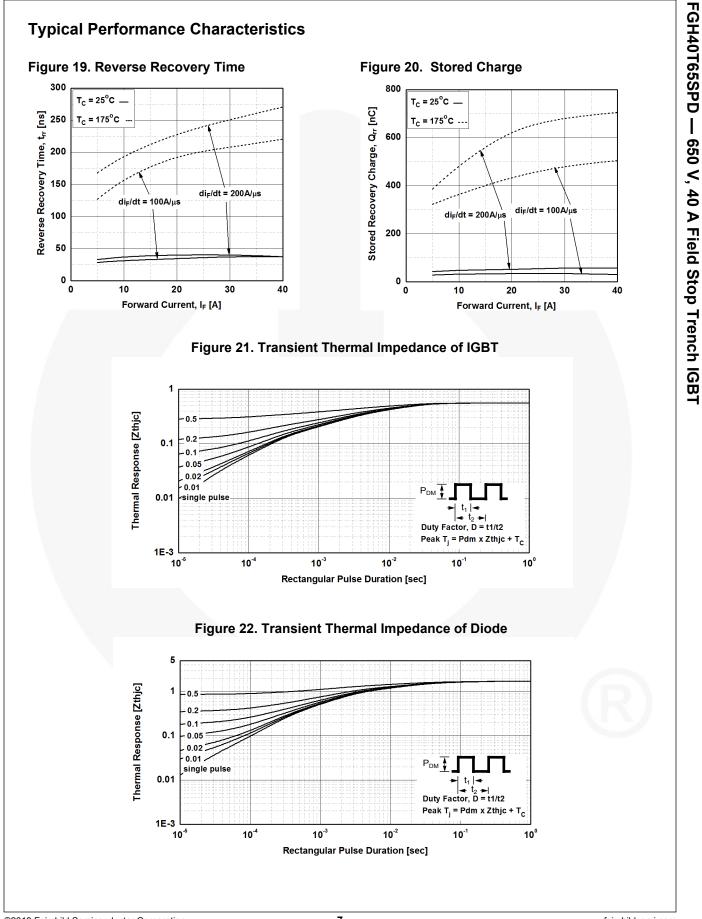
2. T_J = 175[°]C

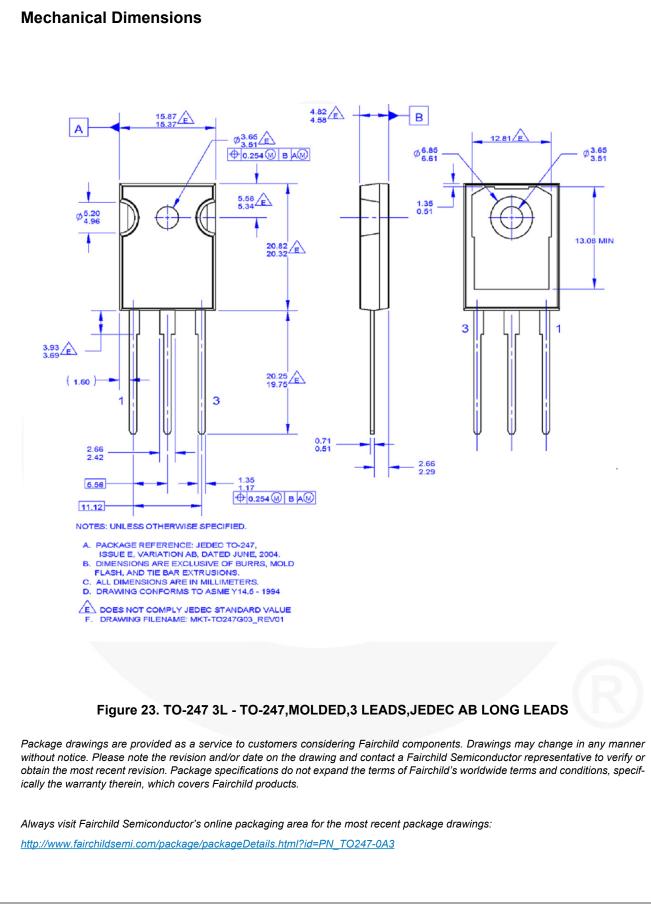
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3. Single Pulse









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